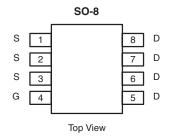




N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	(on) (Ω) $I_D(A)^a$ Q_C			
30	0.0085 at V _{GS} = 10 V	18	11.7 nC		
	0.0125 at V _{GS} = 4.5 V	15	11.7110		

SCHOTTKY AND BODY DIODE PRODUCT SUMMARY				
V _{DS} (V)	V _{SD} (V) Diode Forward Voltage	I _S (A)		
30	0.4 at 2 A	5 ^a		



Ordering Information: Si4322DY-T1-E3 (Lead (Pb)-free)

Si4322DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

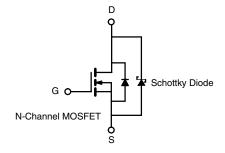
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- 100 % R_g Tested

COMPLIANT HALOGEN FREE



- · Synchronous Buck-Low Side
 - Notebook
 - Server
 - Workstation
- Synchronous Rectifier-POL



ABSOLUTE MAXIMUM RATINGS $T_A =$	= 25 °C, unless other	wise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V_{DS}	30	V	
Gate-Source Voltage		V_{GS}	± 20	'	
	T _C = 25 °C		18	A	
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	15		
	T _A = 25 °C		14 ^{b, c}		
	T _A = 70 °C		11 ^{b, c}		
Pulsed Drain Current		I _{DM}	50	I	
Continuous Source-Drain Diode Current	T _C = 25 °C	la	5		
Continuous Source-Diam Diode Current	T _A = 25 °C	Is	2.8 ^{b, c}		
	T _C = 25 °C		5.4		
Maximum Power Dissipation	T _C = 70 °C	P_{D}	3.4	w	
Maximum Tower Dissipation	T _A = 25 °C	' Б	3.1 ^{b, c}		
	T _A = 70 °C		2.0 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	34	40	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	17	23	0/ **	

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- d. Maximum under Steady State conditions is 85 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.5		3.0	٧	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V		0.18	1	mA	
Zero Gate Voltage Drain Current		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 100 °C		22	100		
On -State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
D : 0	D	V _{GS} = 10 V, I _D = 15 A		0.007	0.0085	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 12 A		0.0095	0.012		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		56		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1640		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		380			
Reverse Transfer Capacitance	C _{rss}	1		118			
Tatal Cata Chausa	Qg	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 15 A		25.5	38	nC	
Total Gate Charge				11.7	17.5		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 15 \text{ A}$		5.1			
Gate-Drain Charge	Q_gd			3.6			
Gate Resistance	R_g	f = 1 MHz		2.3	3.5	Ω	
Turn-On Delay Time	t _{d(on)}			24	36	-	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 3 \Omega$		84	126		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_G = 1 \Omega$		36	54		
Fall Time	t _f			17	26	ns	
Turn-On Delay Time	t _{d(on)}			12	18	113	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 3 \Omega$		36	54	-	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 1 \Omega$		36	54		
Fall Time	t _f			7	11		
Drain-Source Body Diode and Schottky	Characterist			1	, ,		
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			5	Α	
Pulse Diode Forward Current ^a	I _{SM}				50	,,	
Body Diode Voltage	V_{SD}	I _S = 2 A		0.35	0.4	V	
Body Diode Reverse Recovery Time	t _{rr}			26	40	ns	
Body Diode Reverse Recovery Charge Q _{rr}		$I_F = 4 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		16	25	nC	
Reverse Recovery Fall Time	t _a			12.5		no	
Reverse Recovery Rise Time	t _b	Ţ		13.5		ns	

Notes:

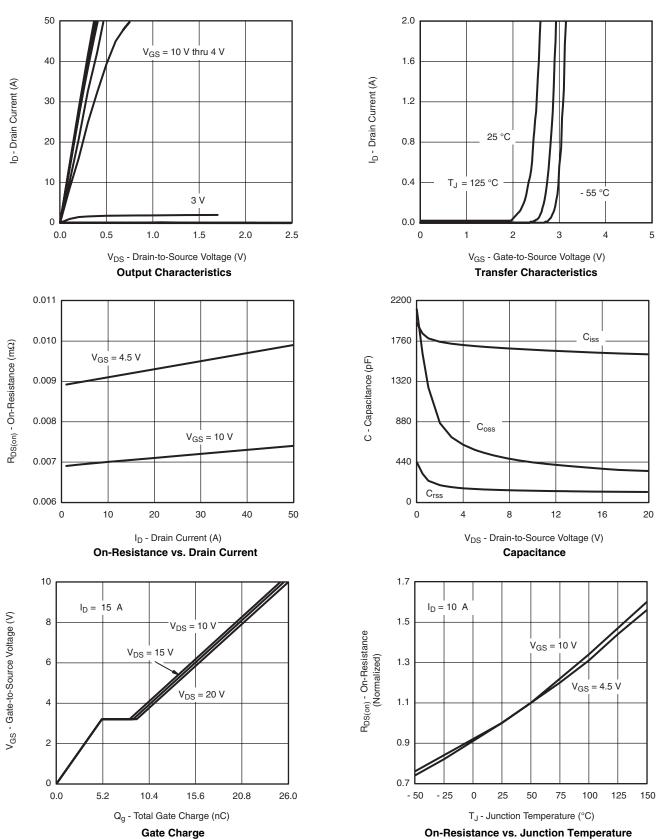
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



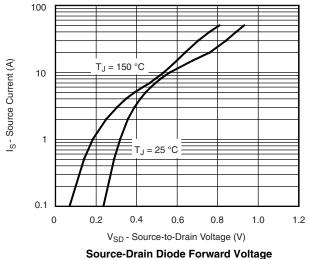


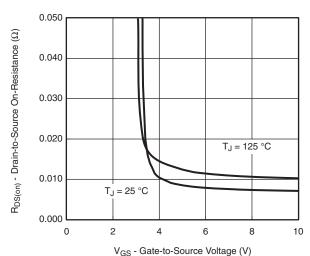
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



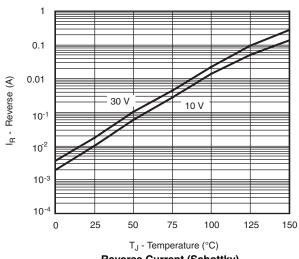
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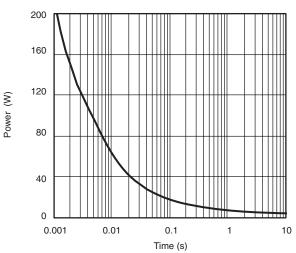
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





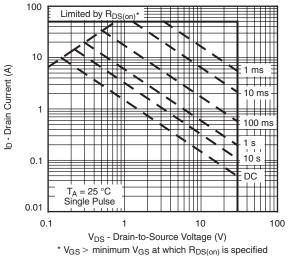






Reverse Current (Schottky)

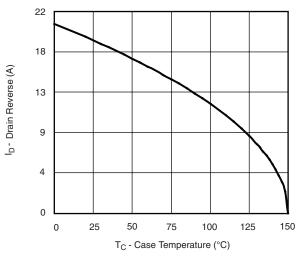
Junction-to-Ambient



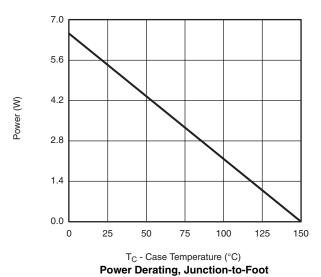
Safe Operating Area

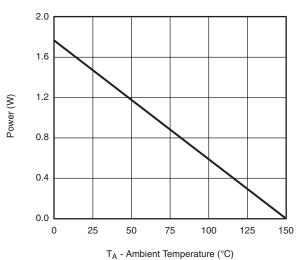


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





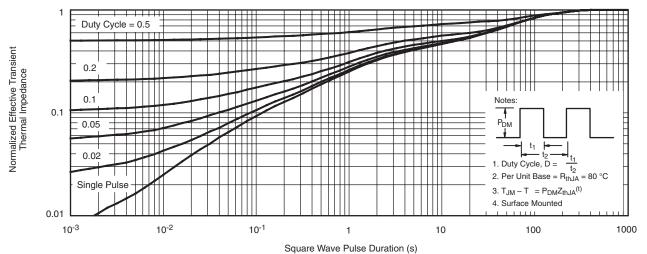
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

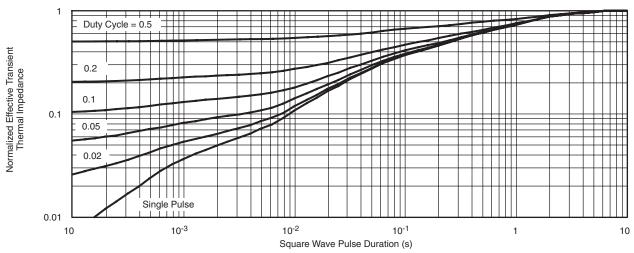
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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